

### Characteristics

$I_o$	1.0	A
$V_{RRM}$	50~800	V
$I_{FSM}$	30.0	A
$V_F$	0.95~1.85	V

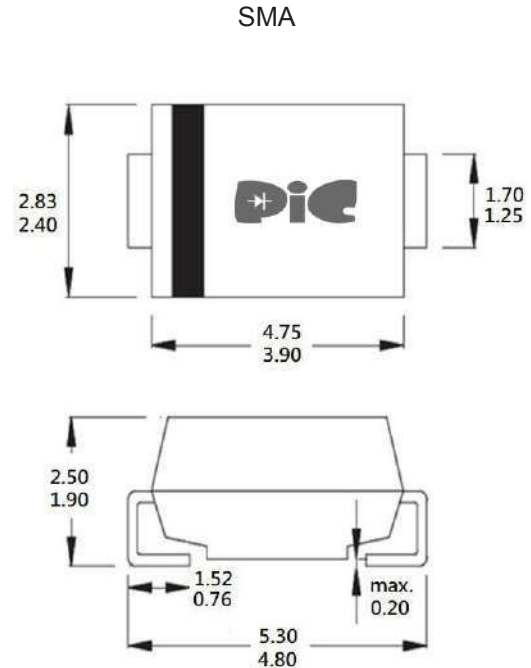
### Features

- Low profile package
- Ideal for automated placement
- Glass passivated chip junction
- High forward surge current capability
- Super fast reverse recovery time
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

### Mechanical Data

- Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant
- Terminals: Tin plated leads, solderable per J-STD-002 and JESD22-B102
- Polarity: Cathode line denotes the cathode end

### Package Outline Dimensions



Unit : millimeters

### Maximum Ratings (TA=25°C unless otherwise noted)

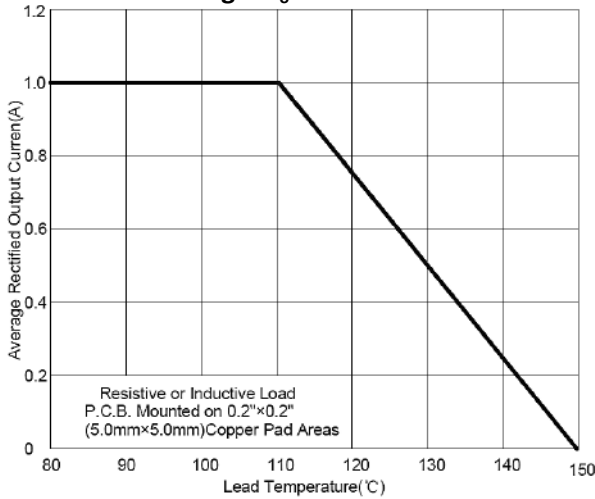
	Symbol	ES1A	ES1B	ES1D	ES1G	ES1J	ES1K	UNITS	
Marking Code	-	ES1A	ES1B	ES1D	ES1G	ES1J	ES1K	-	
Max. Repetitive Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	Volts	
Max. RMS Voltage	$V_{RMS}$	35	70	140	280	420	560	Volts	
Max. DC blocking Voltage	$V_{DC}$	50	100	200	400	600	800	Volts	
Average rectified output current @60Hz sine wave, Resistance load, TL (Fig.1)	$I_o$	1.0						Amps	
Forward Surge Current (Non-repetitive) @60Hz Half-sine wave, 1 cycle, $T_j=25^\circ\text{C}$	$I_{FSM}$	30.0						Amps	
Forward voltage at 1.0A	$V_F$	0.95		1.30		1.70		1.85	Volts
Maximum DC reverse current at rated DC blocking voltage per diode @ $V_{RM}=V_{RRM}$	$T_a=25^\circ\text{C}$	5						$\mu\text{A}$	
	$T_a=125^\circ\text{C}$	100							
Typical thermal resistance (1)	$R_{\theta J-A}$	65						$^\circ\text{C}/\text{W}$	
	$R_{\theta J-L}$	20							
Maximum reverse recovery time $I_F=0.5\text{A}$ , $I_R=1.0\text{A}$ , $I_{rr}=0.25\text{A}$	$T_{RR}$	35						nS	
Operating junction and storage temperature range	$T_J, T_{STG}$	-55 to +150						$^\circ\text{C}$	

### Notes:

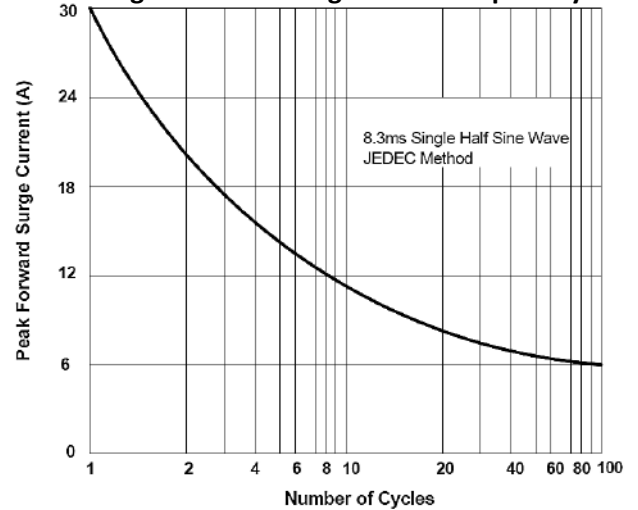
- (1) Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.2"x0.2" (5.0mmx5.0 mm) copper pad areas

### Rating and Characteristics Curves

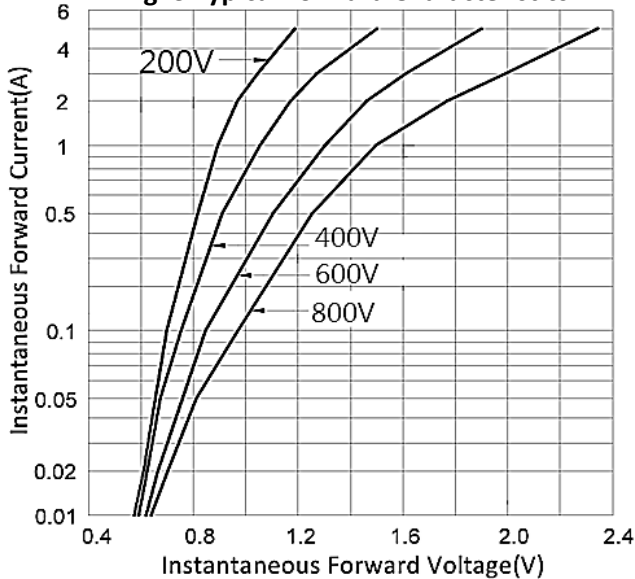
**Fig. 1  $I_o$ -TL Curve**



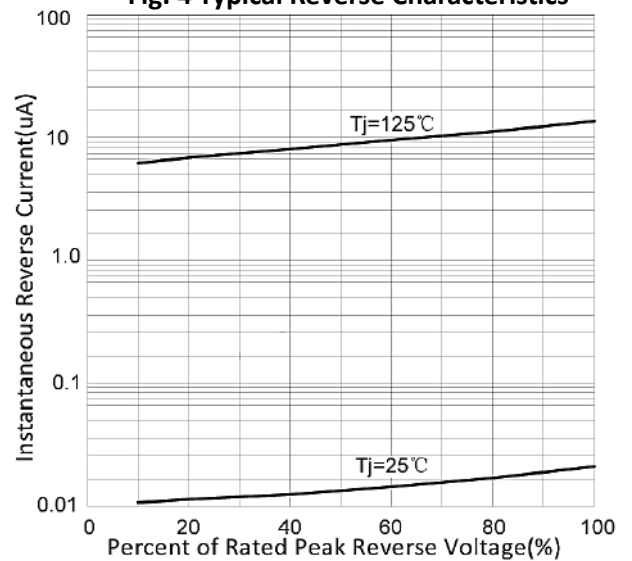
**Fig. 2 Forward Surge Current Capability**



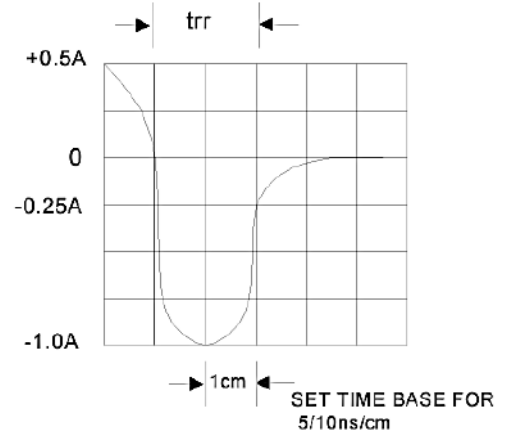
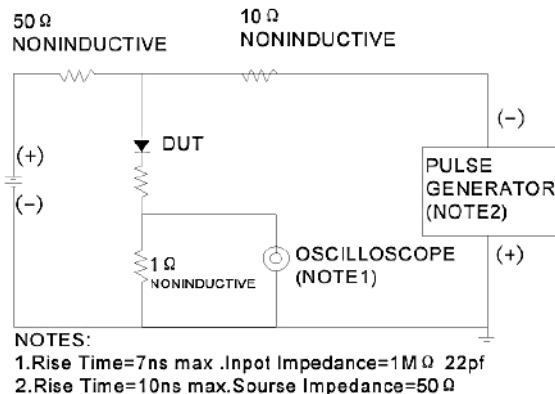
**Fig. 3 Typical Forward Characteristics**



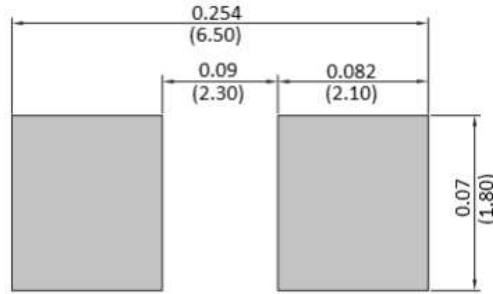
**Fig. 4 Typical Reverse Characteristics**



**Fig. 5 Diagram of circuit and Testing wave form of reverse recovery time**



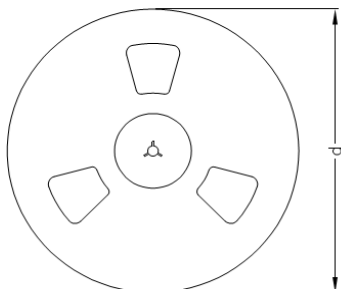
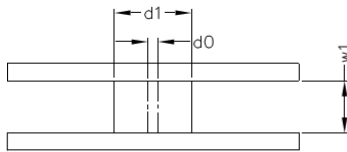
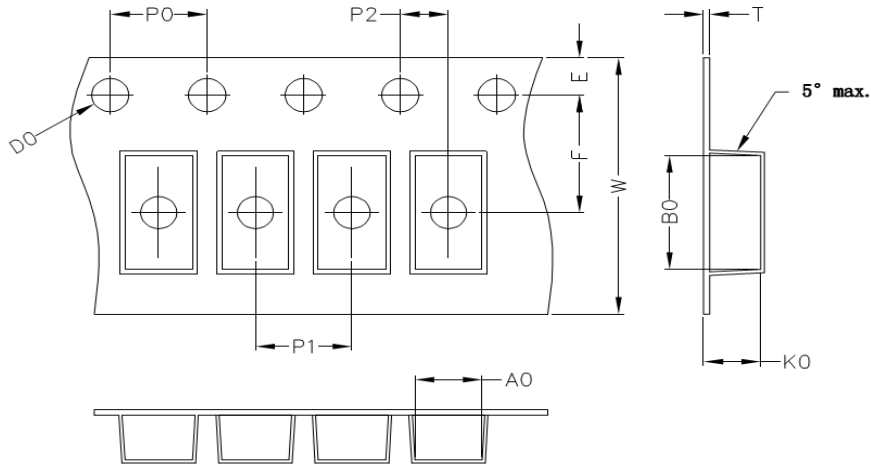
### Pad Layout



Unit: mm

### Packaging Specifications

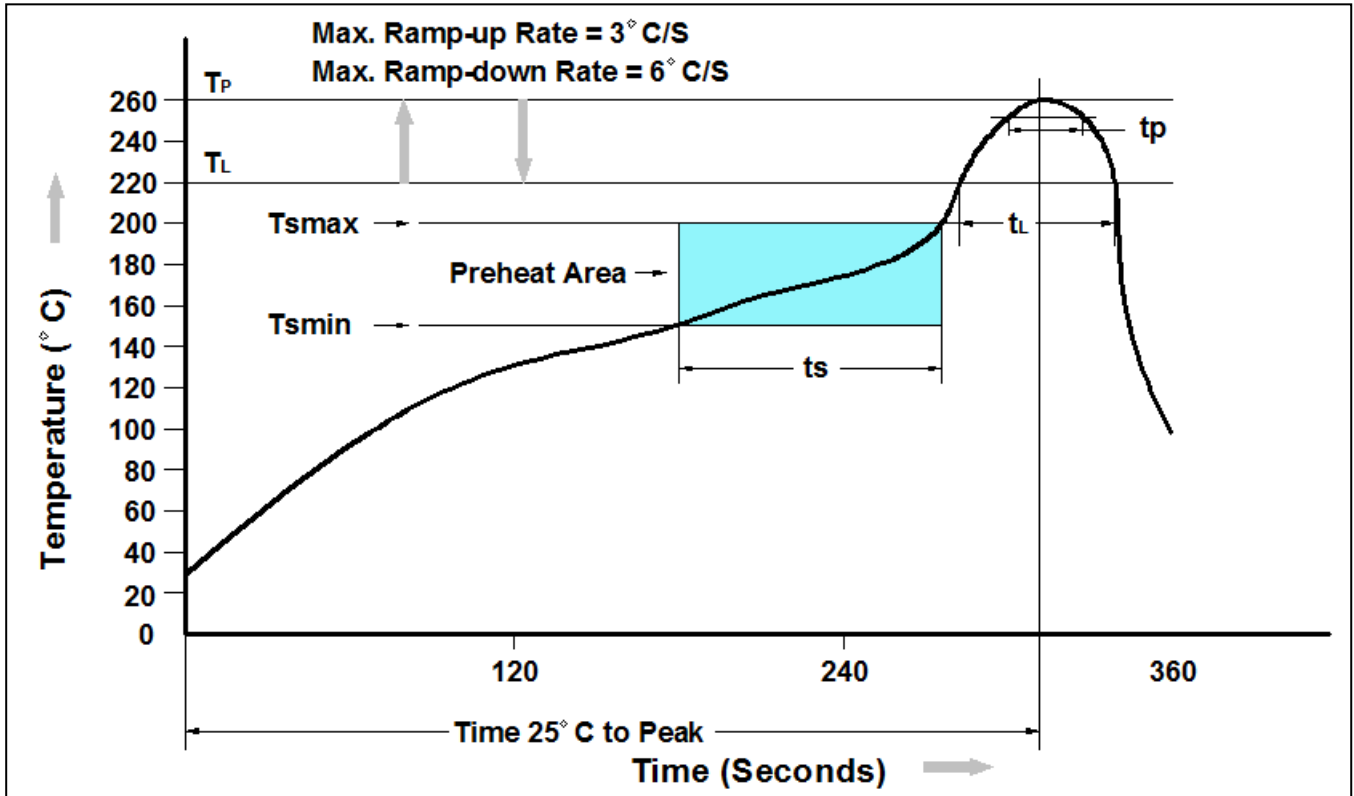
Package	A0 (mm)	B0 (mm)	K0 (mm)	D0 (mm)	E (mm)	F (mm)	P0 (mm)	P1 (mm)	P2 (mm)	T (mm)	W (mm)
SMA	2.8±0.1	5.33±0.1	2.36±0.1	1.55±0.1	1.75±0.1	5.50±0.1	4.0±0.1	4.0±0.01	2±0.1	0.25±0.1	9.4±0.1
SMB	3.8±0.1	5.40±0.1	2.45±0.1	1.55±0.1	1.75±0.1	5.50±0.1	4.0±0.1	8.0±0.01	2±0.1	0.25±0.1	9.4±0.1
SMC	6.05±0.1	8.31±0.1	2.54±0.1	1.55±0.1	1.75±0.1	7.50±0.1	4.0±0.1	8.0±0.05	2±0.1	0.25±0.1	12±0.1



Package	D1 (mm)	D0 (mm)	W1 (mm)	D (mm)
SMA	75	13.5	13.5	330
SMB	75	13.5	13.5	330
SMC	75	13.5	17.0	330

NOTE : The tolerance of reel is ±2mm

### Recommend IR Reflow Soldering Thermal Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (T <sub>smin</sub> )	150°C
Temperature Max. (T <sub>smax</sub> )	200°C
Time (t <sub>s</sub> ) from (T <sub>smin</sub> to T <sub>smax</sub> )	60-120 seconds
Average Ramp-up Rate (t <sub>L</sub> to t <sub>P</sub> )	3°C/second max.
Liquidous Temperature (T <sub>L</sub> )	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of actual Peak Temperature	30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.

### Ordering Information

Part Number	Description	Quantity
ES1A ~ ES1K	SMA Reel	5000 pcs

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